



PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Kie Y. Ahn et al.

Examiner: Ha T. Nguyen

Serial No.: 09/483,881

Group Art Unit: 2812

Filed: January 18, 2000

Docket No.: 303.672US1

Title: SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION

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**AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.111**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Office Action dated July 27, 2005, please amend the application as follows: